TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3217

Measuring Instruments Logic IC Testers / Memory Testers Board Testers / Scanners

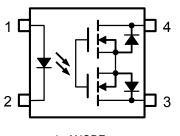
The TOSHIBA TLP3217 is an ultra-small photorelay suitable for surface-mount assembly. The TLP3217 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOSFET and is housed in a 4-pin package.

The TLP3217 is suitable for applications that require low output capacitance and high isolation voltage, such as LCD testers.

Features

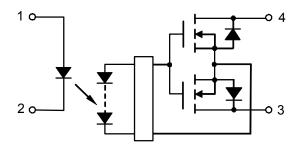
- 4-pin SSOP (SSOP4): 1.8-mm high, 1.27-mm pitch
- 1-Form-A
- Peak Off-State Voltage: 80 V (min)
- Trigger LED Current: 5 mA (max)
- On-State Current: 120 mA (max)
- On-State Resistance: 12Ω (max), 7.5Ω (typ.)
- Output Capacitance: 7.0 pF (max), 5.0 pF (typ.)
- Isolation Voltage: 1500 Vrms (min)

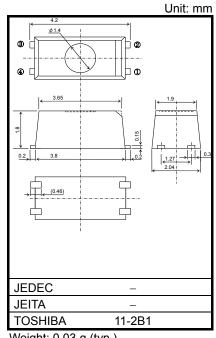
Pin Configuration (Top View)





Schematic





Weight: 0.03 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward Current	١ _F	50	mA
LED	\Box Forward Current Derating (Ta $\ge 25^{\circ}$ C)		-0.5	mA/°C
Щ	Reverse Voltage	V _R	5	V
	Junction Temperature	Tj	125	°C
Ц	Off-State Output Terminal Voltage	V _{OFF}	80	V
DETECTOR	On-State Current	I _{ON}	120	mA
ETE(On-State Current Derating (Ta $\ge 25^{\circ}$ C)	∆l _{ON} /°C	-1.2	mA/°C
	Junction Temperature	Tj	125	°C
Stora	Storage Temperature Range		-40 to125	°C
Oper	Operating Temperature Range		-20 to 85	°C
Lead	Lead Soldering Temperature (10 s)		260	°C
Isolat	tion Voltage (AC, 1 minute, R.H. \leq 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	V _{DD}	_	_	64	V
Forward Current	١ _F	_	_	30	mA
On-State Current	I _{ON}	_	_	120	mA
Operating Temperature	T _{opr}	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note 1: Device considered a two-terminal device: Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward Voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	$V_R = 5 V$	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	15	_	pF
DETECTOR	Off-State Current	IOFF	V _{OFF} = 80 V, Ta = 60°C	_	_	200	pА
DETE	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	_	5.0	7.0	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED Current	I _{FT}	I _{ON} = 120 mA		2	5	mA
Close LED Current	I _{FC}	I _{OFF} = 10 μA	0.1	_	_	mA
On-State Resistance	R _{ON}	I _{ON} = 120 mA, I _F = 5 mA, t < 1 s		7.5	12	Ω

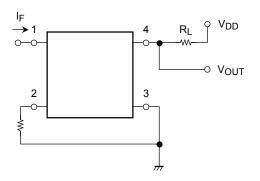
Isolation Characteristics (Ta = 25°C)

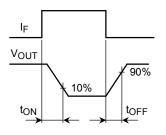
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance Input to Output	CS	$V_{S} = 0 V, f = 1 MHz$	_	0.8	_	pF
Isolation Resistance	R _S	$V_S = 500 \text{ V}, \text{ R.H.} \le 60\%$	5×10^{10}	10 ¹⁴	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	BVS	AC, 1 second (in oil)	—	3000	_	VIIIIS
		DC, 1 minute (in oil)	—	3000		Vdc

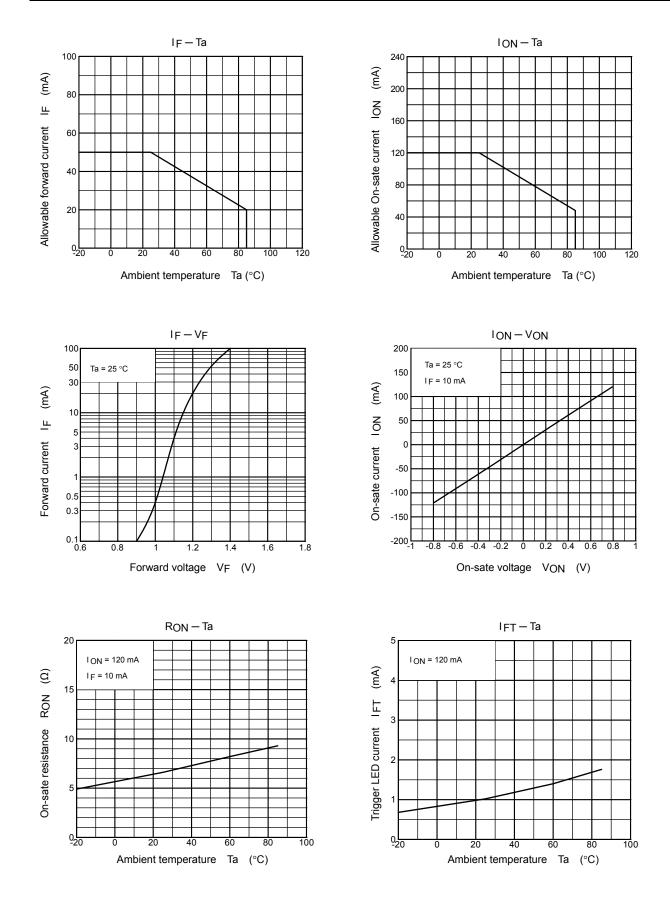
Switching Characteristics (Ta = 25°C)

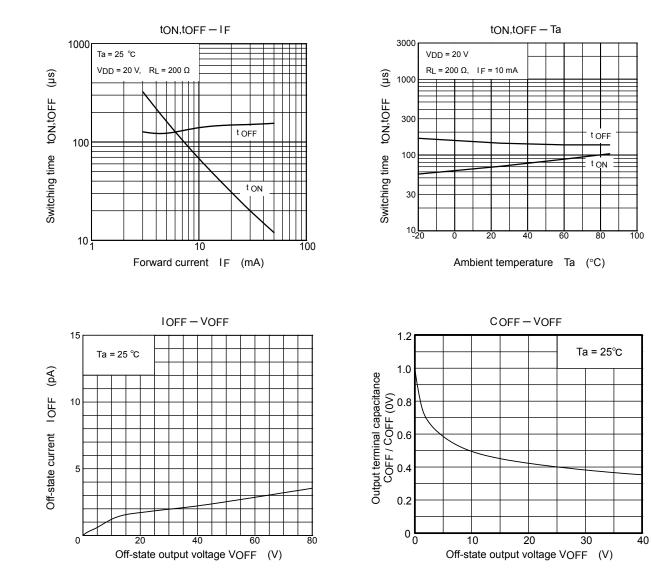
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Turn-on Time	t _{ON}	$R_L = 200 \Omega$ (Not	e) —	200	500	
Turn-off Time	tOFF	V _{DD} =20 V, I _F = 5 mA	—	150	200	μS
Turn-on Time	t _{ON}	$R_L = 200 \Omega$ (Not	e) —	100	250	μο
Turn-off Time	tOFF	V _{DD} =20 V, I _F = 10 mA	—	150	200	

Note: Switching time test circuit

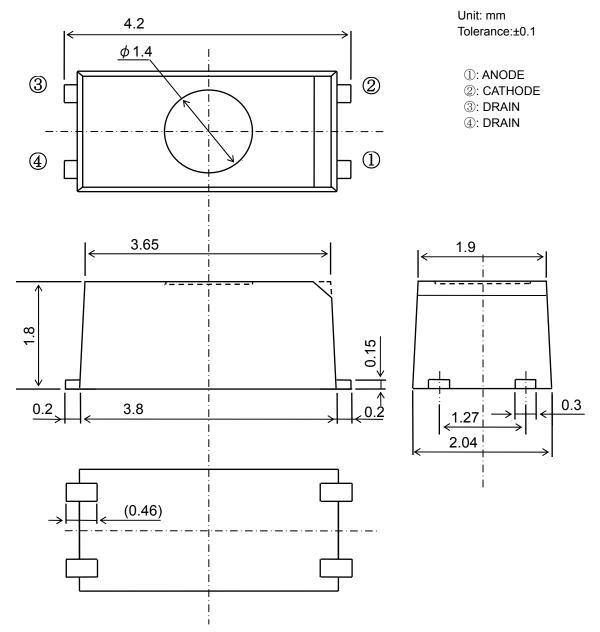








Package Dimensions



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